

MOSFET

OptiMOS[™] 5 Power-Transistor, 80 V

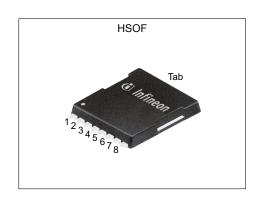
Features

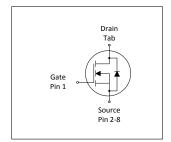
- Ideal for high frequency switching and sync. rec.
 Excellent gate charge x R_{DS(on)} product (FOM)
 Very low on-resistance R_{DS(on)}
 N-channel, normal level

- 100% avalanche tested
- Pb-free plating; RoHS compliant
 Qualified according to JEDEC¹⁾ for target applications
 Halogen-free according to IEC61249-2-21



Parameter	Value	Unit		
$V_{ extsf{DS}}$	80	V		
R _{DS(on),max}	1.2	mΩ		
I _D	400	A		
Q _{oss}	208	nC		
Q _G (0V10V)	178	nC		











Type / Ordering Code	Package	Marking	Related Links
IPT012N08N5	PG-HSOF-8	012N08N5	-

OptiMOS[™] 5 Power-Transistor, 80 V



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OptiMOS[™] 5 Power-Transistor, 80 V IPT012N08N5



1 Maximum ratings at T_A =25 °C, unless otherwise specified

Table 2 Maximum ratings

Davamatan	O	Values			1114	N
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Continuous drain current ¹⁾	ID	- - -	-	400 283 56	A	$V_{\rm GS}$ =10 V, $T_{\rm C}$ =25 °C $V_{\rm GS}$ =10 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =10 V, $T_{\rm A}$ =25 °C, $R_{\rm thJA}$ =40 K/W ²⁾
Pulsed drain current ³⁾	I _{D,pulse}	-	-	1600	Α	T _C =25 °C
Avalanche energy, single pulse ⁴⁾	E AS	-	-	817	mJ	I _D =150 A, R _{GS} =25 Ω
Gate source voltage	V _{GS}	-20	-	20	V	-
Power dissipation	P _{tot}	-	-	375	W	T _C =25 °C
Operating and storage temperature	T _j , T _{stg}	-55	-	175	°C	IEC climatic category; DIN IEC 68-1: 55/175/56

2 Thermal characteristics

Table 3 Thermal characteristics

Developed	Cymbal	Values			11	Note / Took Condition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Thermal resistance, junction - case	R _{thJC}	-	0.2	0.4	K/W	-
Device on PCB, minimal footprint	R _{thJA}	-	-	62	K/W	-
Device on PCB, 6 cm² cooling area²)	R _{thJA}	_	-	40	K/W	-

¹⁾ Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature at 25 °C. For higher *case temperature* please refer to Diagram 2. De-rating will be required based on the actual environmental conditions. $^{2)}$ Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm² (one layer, 70 μ m thick) copper area for drain

connection. PCB is vertical in still air.

3) See figure 3 for more detailed information

4) See figure 13 for more detailed information

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3 Electrical characteristics

at T_j=25 °C, unless otherwise specified

Table 4 Static characteristics

Parameter	0	Values				
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Drain-source breakdown voltage	V _{(BR)DSS}	80	-	-	V	V _{GS} =0 V, I _D =1 mA
Gate threshold voltage	V _{GS(th)}	2.2	3.0	3.8	V	$V_{\rm DS} = V_{\rm GS}, I_{\rm D} = 280 \ \mu {\rm A}$
Zero gate voltage drain current	I _{DSS}	-	0.1 10	1 100	μΑ	V _{DS} =80 V, V _{GS} =0 V, T _j =25 °C V _{DS} =80 V, V _{GS} =0 V, T _j =125 °C
Gate-source leakage current	I_{GSS}	-	10	100	nA	V _{GS} =20 V, V _{DS} =0 V
Drain-source on-state resistance	R _{DS(on)}	-	1.0 1.3	1.2 1.7	mΩ	V _{GS} =10 V, I _D =150 A V _{GS} =6 V, I _D =75 A
Gate resistance ¹⁾	R _G	-	1.6	2.4	Ω	-
Transconductance	g fs	120	250	-	S	$ V_{DS} > 2 I_D R_{DS(on)max}, I_D = 100 A$

Table 5 Dynamic characteristics¹⁾

Parameter	Ob. a.l.		Values			Nata / Tank Oam distant
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Input capacitance	C _{iss}	-	13000	17000	pF	V _{GS} =0 V, V _{DS} =40 V, <i>f</i> =1 MHz
Output capacitance	Coss	-	2000	2600	pF	V _{GS} =0 V, V _{DS} =40 V, <i>f</i> =1 MHz
Reverse transfer capacitance	C _{rss}	-	86	150	pF	V _{GS} =0 V, V _{DS} =40 V, <i>f</i> =1 MHz
Turn-on delay time	$t_{\sf d(on)}$	-	35	-	ns	$V_{\rm DD}$ =40 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =100 A, $R_{\rm G,ext}$ =1.8 Ω
Rise time	t _r	-	31	-	ns	$V_{\rm DD}$ =40 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =100 A, $R_{\rm G,ext}$ =1.8 Ω
Turn-off delay time	$t_{ m d(off)}$	-	82	-	ns	$V_{\rm DD}$ =40 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =100 A, $R_{\rm G,ext}$ =1.8 Ω
Fall time	t _f	-	30	-	ns	$V_{\rm DD}$ =40 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =100 A, $R_{\rm G,ext}$ =1.8 Ω

Table 6 Gate charge characteristics²⁾

Parameter	Ols all	Values				
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Gate to source charge	Q _{gs}	-	56	-	nC	$V_{\rm DD}$ =40 V, $I_{\rm D}$ =100 A, $V_{\rm GS}$ =0 to 10 V
Gate charge at threshold	$Q_{g(th)}$	-	38	-	nC	$V_{\rm DD}$ =40 V, $I_{\rm D}$ =100 A, $V_{\rm GS}$ =0 to 10 V
Gate to drain charge ¹⁾	Q _{gd}	-	37	56	nC	$V_{\rm DD}$ =40 V, $I_{\rm D}$ =100 A, $V_{\rm GS}$ =0 to 10 V
Switching charge	Q _{sw}	-	56	-	nC	$V_{\rm DD}$ =40 V, $I_{\rm D}$ =100 A, $V_{\rm GS}$ =0 to 10 V
Gate charge total ¹⁾	Qg	-	178	223	nC	$V_{\rm DD}$ =40 V, $I_{\rm D}$ =100 A, $V_{\rm GS}$ =0 to 10 V
Gate plateau voltage	$V_{ m plateau}$	-	4.5	-	V	$V_{\rm DD}$ =40 V, $I_{\rm D}$ =100 A, $V_{\rm GS}$ =0 to 10 V
Gate charge total, sync. FET	Q _{g(sync)}	-	154	-	nC	V _{DS} =0.1 V, V _{GS} =0 to 10 V
Output charge ¹⁾	Q _{oss}	-	208	276	nC	V _{DD} =40 V, V _{GS} =0 V

 $^{^{1)}}$ Defined by design. Not subject to production test. $^{2)}$ See "Gate charge waveforms" for parameter definition

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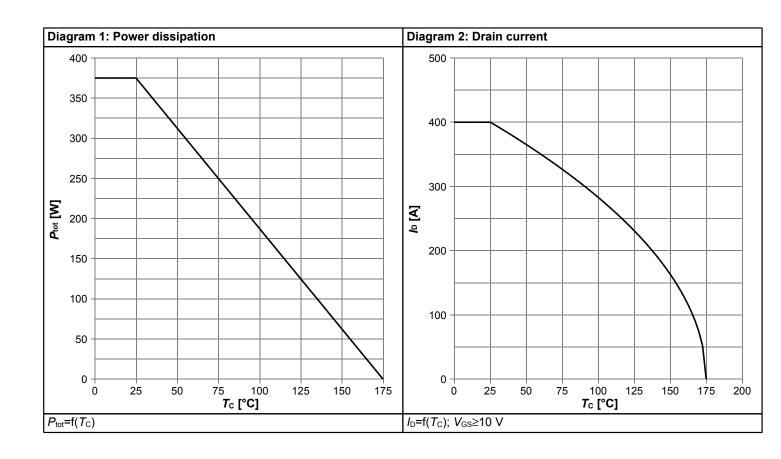


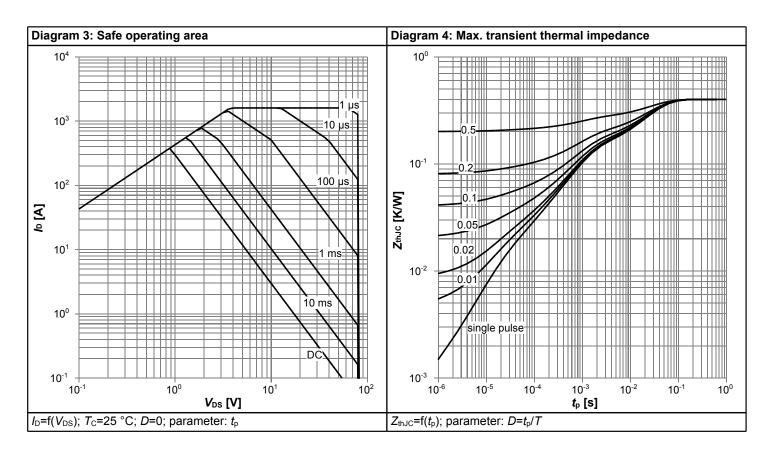
Table 7 Reverse diode

Douglaston	Complete		Values			Nata / Tant Can dition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Diode continuous forward current	Is	-	-	269	Α	T _C =25 °C	
Diode pulse current	I _{S,pulse}	-	-	1600	Α	T _C =25 °C	
Diode forward voltage	V _{SD}	-	0.88	1.2	V	V _{GS} =0 V, I _F =150 A, T _j =25 °C	
Reverse recovery time ¹⁾	t _{rr}	-	106	212	ns	V _R =40 V, I _F =100A, di _F /dt=100 A/μs	
Reverse recovery charge ¹⁾	Qrr	-	318	636	nC	V _R =40 V, I _F =100A, d <i>i</i> _F /d <i>t</i> =100 A/μs	

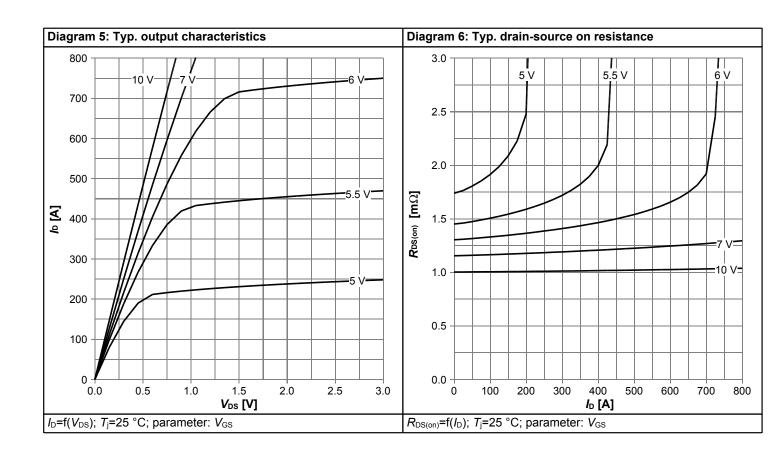


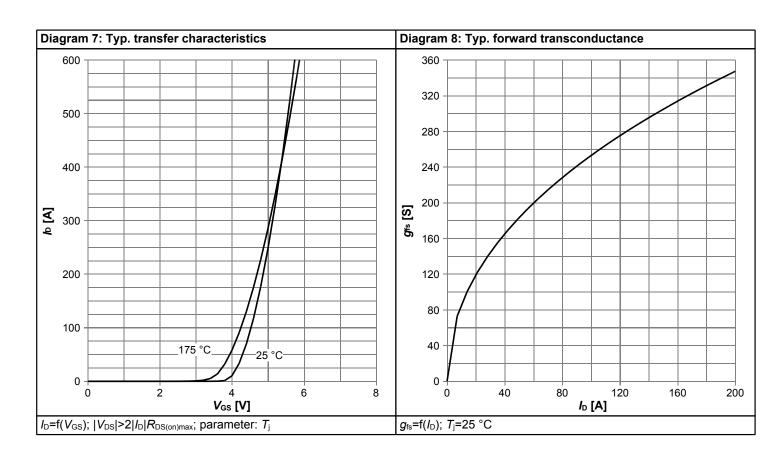
4 Electrical characteristics diagrams



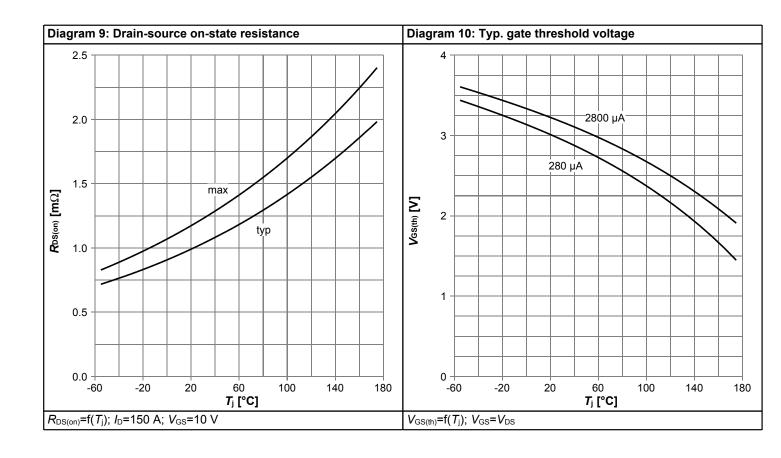


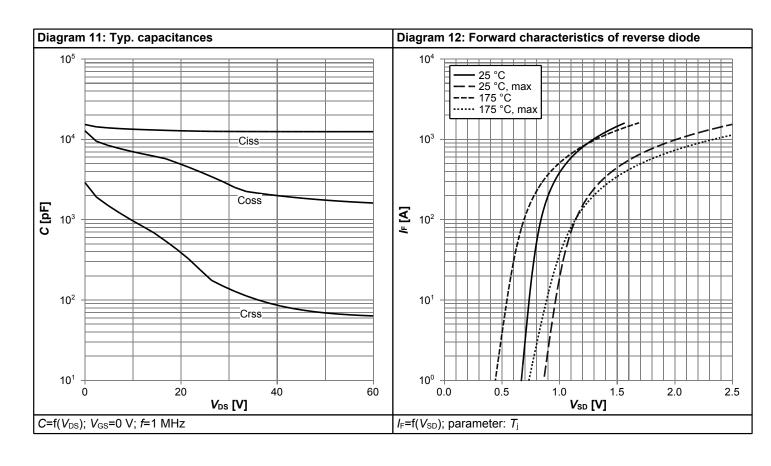




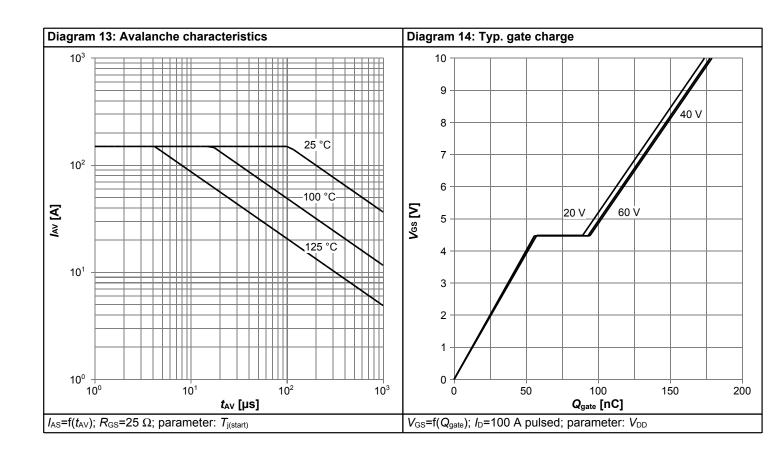


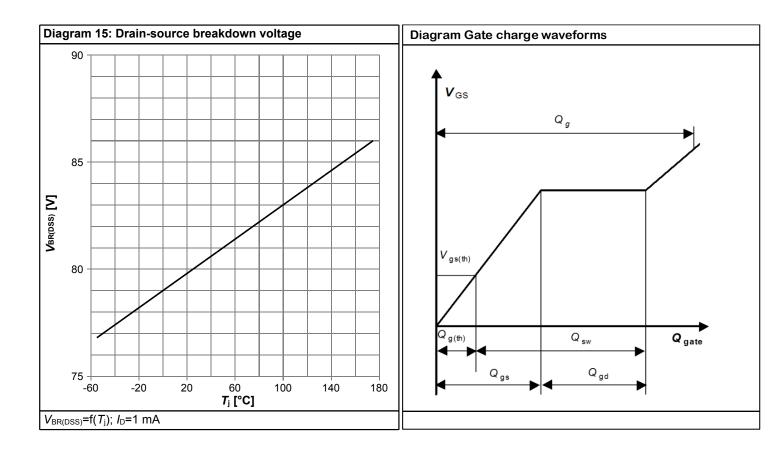














5 Package Outlines

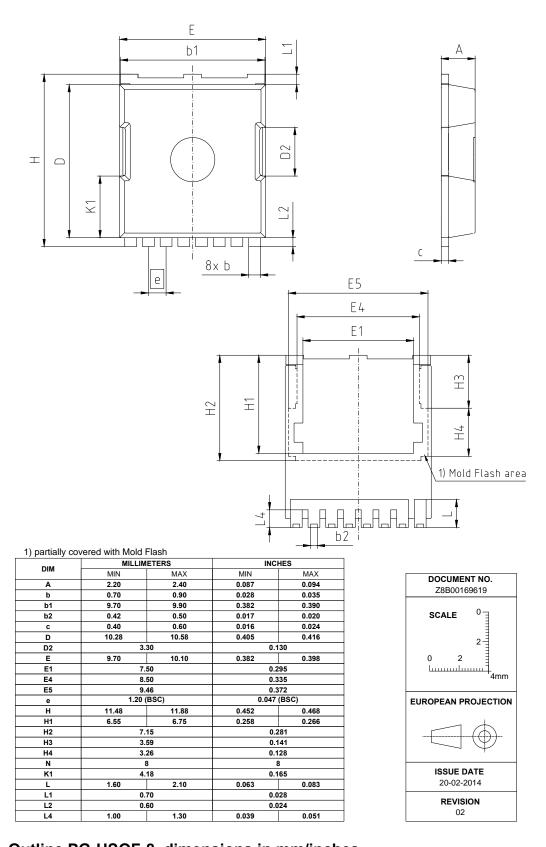


Figure 1 Outline PG-HSOF-8, dimensions in mm/inches

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Revision History

IPT012N08N5

Revision: 2020-10-23, Rev. 2.3

Previous Revision

1 reviews revision							
Revision	Date	Subjects (major changes since last revision)					
2.0	2014-12-17	Release of final version					
2.1	2015-02-23	Update active area about 0.3%					
2.2	2017-03-20	Update condition "T" in " Maximum ratings "					
2.3	2020-10-23	Update product current					

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